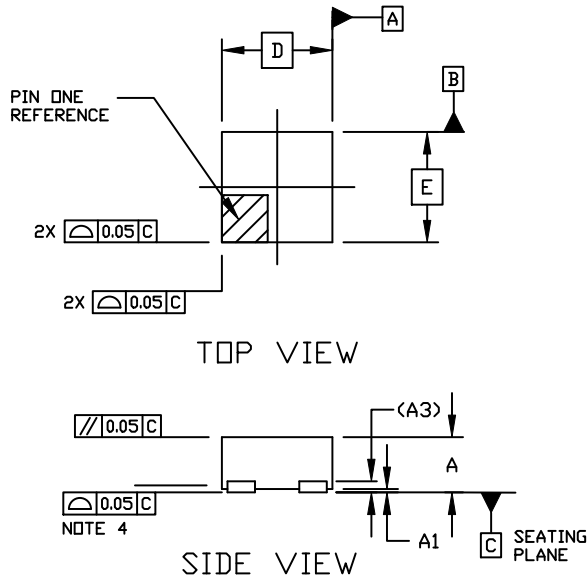


MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS



XDFN4 1.0x1.0, 0.65P
CASE 711AJ
ISSUE C

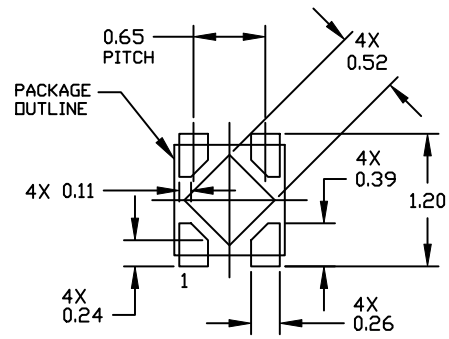
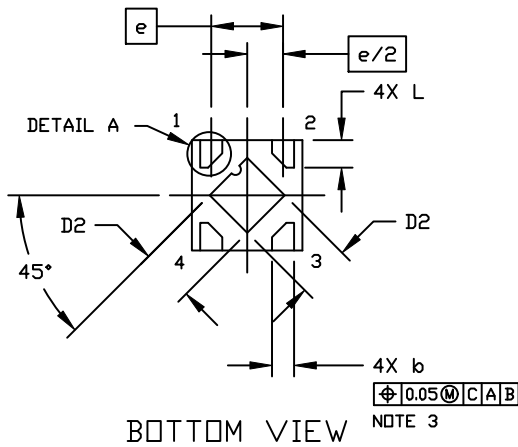
DATE 08 MAR 2022



NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS
3. DIMENSION *b* APPLIES TO THE PLATED TERMINALS AND IS MEASURED BETWEEN 0.15 AND 0.20 FROM THE TERMINAL TIPS.
4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

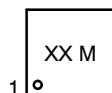
DIM	MILLIMETERS		
	MIN	NOM	MAX
A	0.33	0.38	0.43
A1	0.00	---	0.05
A3	0.10 REF		
<i>b</i>	0.15	0.20	0.25
<i>b</i> 2	0.02	0.07	0.12
D	0.90	1.00	1.10
D2	0.43	0.48	0.53
E	0.90	1.00	1.10
<i>e</i>	0.65 BSC		
L	0.20		0.30
L2	0.07		0.17



**RECOMMENDED
MOUNTING FOOTPRINT**

* FOR ADDITIONAL INFORMATION ON OUR Pb-FREE STRATEGY AND SOLDERING DETAILS, PLEASE DOWNLOAD THE ONSEMI SOLDERING AND MOUNT TECHNIQUES REFERENCE MANUAL, SOLDERRM/D

GENERIC MARKING DIAGRAM*



XX = Specific Device Code
M = Date Code

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

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DESCRIPTION:	XDFN4, 1.0X1.0, 0.65P	PAGE 1 OF 1

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